

FAST CMOS OCTAL TRANSPARENT LATCH

IDT74FCT2373AT/CT

FEATURES:

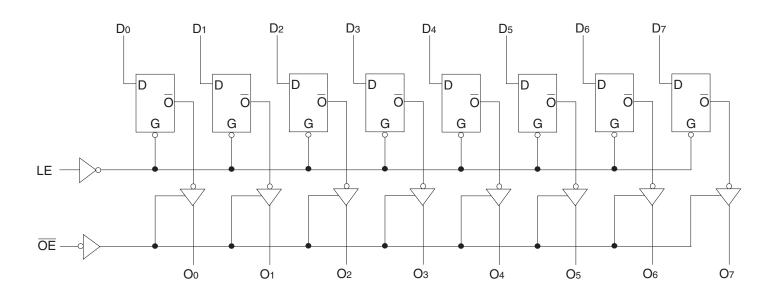
- · A and C grades
- Low input and output leakage ≤1µA (max.)
- · CMOS power levels
- True TTL input and output compatibility:
 - VOH = 3.3V (typ.)
 - -VOL = 0.3V (typ.)
- · Meets or exceeds JEDEC standard 18 specifications
- · Resistor outputs -15mA IOH, 12mA IOL
- Reduced system switching noise
- · Available in QSOP package

DESCRIPTION:

The FCT2373T is an octal transparent latch built using an advanced dual metal CMOS technology. These octal latches have 3-state outputs and are intended for bus oriented applications. The flip-flops appear transparent to the data when Latch Enable (LE) is high. When LE is low, the data that meets the set-up time is latched. Data appears on the bus when the Output Enable (\overline{OE}) is low. When \overline{OE} is high, the bus output is in the high-impedance state.

The FCT2373T has balanced drive outputs with current limiting resistors. This offers low ground bounce, minimal undershoot and controlled output fall times-reducing the need for external series terminating resistors. The FCT2373T parts are plug-in replacements for FCT373T parts.

FUNCTIONAL BLOCK DIAGRAM

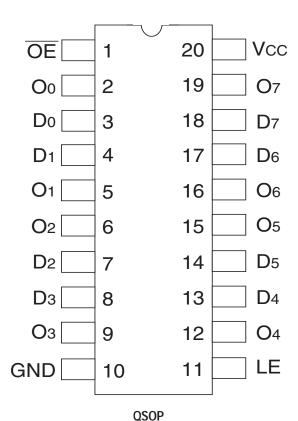


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INDUSTRIAL TEMPERATURE RANGE

SEPTEMBER 2009

PIN CONFIGURATION



TOP VIEW

ABSOLUTE MAXIMUM RATINGS(1)

Symbol	Description	Max	Unit
VTERM ⁽²⁾	Terminal Voltage with Respect to GND	-0.5 to +7	٧
VTERM ⁽³⁾	Terminal Voltage with Respect to GND	-0.5 to Vcc+0.5	V
Tstg	Storage Temperature	-65 to +150	°C
Іоит	DC Output Current	-60 to +120	mA

NOTES:

- 1. Stresses greater than those listed under ABSOLUTE MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability. No terminal voltage may exceed Vcc by +0.5V unless otherwise noted.
- 2. Inputs and Vcc terminals only.
- 3. Output and I/O terminals only.

CAPACITANCE (TA = +25°C, F = 1.0MHz)

	Symbol	Parameter ⁽¹⁾	Conditions	Тур.	Max.	Unit
	CIN	Input Capacitance	VIN = 0V	6	10	pF
ĺ	Соит	Output Capacitance	Vout = 0V	8	12	pF

NOTE:

1. This parameter is measured at characterization but not tested.

PIN DESCRIPTION

Pin Names	Description	
Dx	Data Inputs	
LE	Latch Enable Input (Active HIGH)	
ŌĒ	Output Enable Input (Active LOW)	
Ох	3-State Outputs	

FUNCTION TABLE(1)

	Outputs		
Dx	LE	ŌĒ	Ох
L	Н	L	L
Н	Н	L	Н
Х	Х	Н	Z

NOTE:

- 1. H = HIGH Voltage Level
 - X = Don't Care
 - L = LOW Voltage Level
 - Z = High Impedance

DC ELECTRICAL CHARACTERISTICS OVER OPERATING RANGE

Following Conditions Apply Unless Otherwise Specified:

Industrial: TA = -40°C to +85°C, VCC = $5.0V \pm 5\%$

Symbol	Parameter	Test Conditions ⁽¹⁾		Min.	Typ. ⁽²⁾	Max.	Unit
VIH	Input HIGH Level	Guaranteed Logic HIGH Level		2	_	_	V
VIL	Input LOW Level	Guaranteed Logic LOW Level		_	_	0.8	V
lih	Input HIGH Current ⁽⁴⁾	Vcc = Max.	VI = 2.7V	_	_	±1	μA
lıL	Input LOW Current ⁽⁴⁾	Vcc = Max.	VI = 0.5V	_	_	±1	μA
lozh	High Impedance Output Current	Vcc = Max.	VI = 2.7V	_	_	±1	μA
lozl	(3-State Output Pins)(4)		VI = 0.5V	_	_	±1	
lı	Input HIGH Current ⁽⁴⁾	Vcc = Max., Vi = Vcc (Max.)		_	_	±1	μA
Vik	Clamp Diode Voltage	Vcc = Min., IIN = -18mA		_	-0.7	-1.2	V
VH	Input Hysteresis	_		_	200	_	mV
Icc	Quiescent Power Supply Current	Vcc = Max. Vin = GND or Vcc		_	0.01	1	mA

OUTPUT DRIVE CHARACTERISTICS

Symbol	Parameter	Test Conditions ⁽¹⁾		Min.	Typ. ⁽²⁾	Max.	Unit
IODL	Output LOW Current	$VCC = 5V$, $VIN = VIH or VIL$, $VOUT = 1.5V^{(3)}$		16	48	_	mA
IODH	Output HIGH Current	$VCC = 5V$, $VIN = VIH or VIL$, $VOUT = 1.5V^{(3)}$		-16	-48	_	mA
Vон	Output HIGH Voltage	Vcc = Min	IOH = -15mA	2.4	3.3	_	V
		VIN = VIH or VIL					
Vol	Output LOW Voltage	Vcc = Min	IoL = 12mA	_	0.3	0.5	V
		VIN = VIH or VIL					

NOTES:

- 1. For conditions shown as Min. or Max., use appropriate value specified under Electrical Characteristics for the applicable device type.
- 2. Typical values are at Vcc = 5.0V, +25°C ambient.
- 3. Not more than one output should be tested at one time. Duration of the test should not exceed one second.
- 4. The test limit for this parameter is $\pm 5\mu A$ at TA = -55°C.

POWER SUPPLY CHARACTERISTICS

Symbol	Parameter	Test Condition	ons ⁽¹⁾	Min.	Typ. ⁽²⁾	Max.	Unit
∆lcc	Quiescent Power Supply Current TTL Inputs HIGH	$VCC = Max.$ $VIN = 3.4V^{(3)}$		_	0.5	2	mA
ICCD	Dynamic Power Supply Current ⁽⁴⁾	Vcc = Max. Outputs Open OE = GND One Input Toggling 50% Duty Cycle	VIN = VCC VIN = GND	_	0.06	0.12	mA/ MHz
Ic	Total Power Supply Current ⁽⁶⁾	Vcc = Max. Outputs Open fi = 10MHz	VIN = VCC VIN = GND	_	0.6	2.2	mA
		50% Duty Cycle OE = GND LE = Vcc	VIN = 3.4V VIN = GND	_	0.9	3.2	
		One BitToggling					
		Vcc = Max. Outputs Open fi = 2.5MHz	VIN = VCC VIN = GND	_	1.2	3.4(5)	
		50% Duty Cycle OE = GND LE = Vcc Eight Bits Toggling	VIN = 3.4V VIN = GND	_	3.2	11.4 ⁽⁵⁾	

NOTES:

- 1. For conditions shown as Min. or Max., use appropriate value specified under Electrical Characteristics for the applicable device type.
- 2. Typical values are at Vcc = 5.0V, +25°C ambient.
- 3. Per TTL driven input; (VIN = 3.4V). All other inputs at Vcc or GND.
- 4. This parameter is not directly testable, but is derived for use in Total Power Supply Calculations.
- 5. Values for these conditions are examples of Δ Icc formula. These limits are guaranteed but not tested.
- 6. IC = IQUIESCENT + INPUTS + IDYNAMIC
 - $IC = ICC + \Delta ICC DHNT + ICCD (fCP/2+ fiNi)$
 - Icc = Quiescent Current
 - ΔICC = Power Supply Current for a TTL High Input (VIN = 3.4V)
 - DH = Duty Cycle for TTL Inputs High
 - NT = Number of TTL Inputs at DH
 - ICCD = Dynamic Current caused by an Input Transition Pair (HLH or LHL)
 - fcp = Clock Frequency for Register Devices (Zero for Non-Register Devices)
 - fi = Output Frequency
 - Ni = Number of Outputs at fi
- All currents are in milliamps and all frequencies are in megahertz.

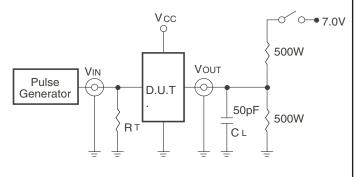
SWITCHING CHARACTERISTICS OVER OPERATING RANGE(1)

			74FCT2373AT		74FCT2	2373CT	
Symbol	Parameter	Condition ⁽¹⁾	Min. ⁽²⁾	Max.	Min. ⁽²⁾	Max.	Unit
tplh	Propagation Delay	CL = 50 pF	1.5	5.2	1.5	4.2	ns
tPHL	Dx to Ox	$RL = 500\Omega$					
tPLH	Propagation Delay		2	8.5	2	5.5	ns
tPHL	LE to Ox						
tpzh	Output Enable Time		1.5	6.5	1.5	5.5	ns
tpzl							
tphz	Output Disable Time		1.5	5.5	1.5	5	ns
tPLZ							
tsu	Set-up Time HIGH or LOW, Dx to LE		2	_	2	_	ns
tH	Hold Time HIGH or LOW, Dx to LE		1.5	_	1.5	_	ns
tw	LE Pulse Width HIGH ⁽³⁾		5	_	5	_	ns

NOTES:

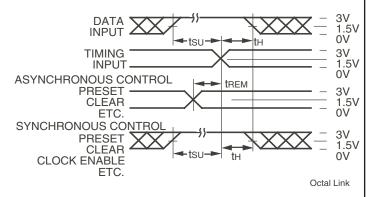
- 1. See test circuit and waveforms.
- 2. Minimum limits are guaranteed but not tested on Propagation Delays.
- 3. This parameter is guaranteed but not tested.

TEST CIRCUITS AND WAVEFORMS

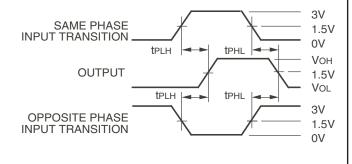


Test Circuits for All Outputs

Octal Link



Set-Up, Hold, and Release Times



Propagation Delay

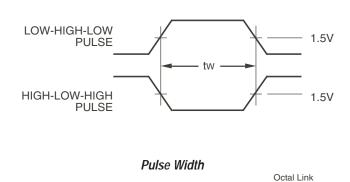
SWITCH POSITION

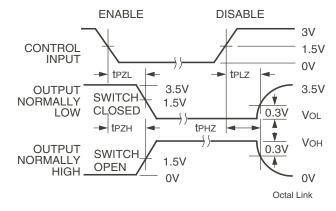
Test	Switch
Open Drain Disable Low Enable Low	Closed
All Other Tests	Open

DEFINITIONS:

CL = Load capacitance: includes jig and probe capacitance.

RT = Termination resistance: should be equal to ZouT of the Pulse Generator.





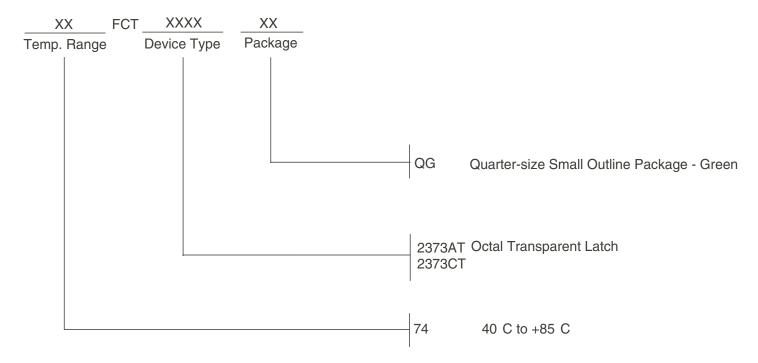
Enable and Disable Times

NOTES:

Octal Link

- 1. Diagram shown for input Control Enable-LOW and input Control Disable-HIGH.
- 2. Pulse Generator for All Pulses: Rate \leq 1.0MHz; tF \leq 2.5ns; tR \leq 2.5ns.

ORDERING INFORMATION



Datasheet Document History

09/29/09 Pg. 7 Updated the ordering information by removing the "IDT" notation and non RoHS part.

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